

Meeting Purpose: The objective for this meeting is for feedback on the detailed design on the structural components of the enclosure subsystem.

Materials to be Reviewed: *Detailed Design Review Package, Mechanical Engineering Section, Rev. 02*

Meeting Date: 02/13/09

Meeting Location: 09-2550

Meeting Time: 1:00 PM – 1:50 PM

Timeline:

Meeting Timeline		
Start Time	Topic of Review	Required Attendees
1:00	Specifications Review	Prof. Slack, Dr. Lam, Dr. Kempinski, Anthony Berwin, Scott Rioux
1:10	Enclosure Subsystem Review <ul style="list-style-type: none"> • Part Models • Assembly Models • Part Drawings • List of Materials 	Prof. Slack, Dr. Lam, Dr. Kempinski, Anthony Berwin, Scott Rioux
1:30	Structural & Vibrations Analysis <ul style="list-style-type: none"> • Hand Analysis • Computer Analysis 	Prof. Slack, Dr. Lam, Dr. Kempinski, Anthony Berwin, Scott Rioux